Onsemi

IGBT - Power, Co-PAK N-Channel, Field Stop IV, MQ (Medium Speed), TO247-4L 650 V, 1.45 V, 75 A FGH4L75T65MQDC50

Using the novel field stop 4th generation IGBT technology and generation 1.5 SiC Schottky Diode technology in TO-247 4-lead package, FGH4L75T65MQDC50 offers the optimum performance with both low conduction and switching losses for high-efficiency operations in various applications, especially totem pole bridgeless PFC and Inverter.

Features

- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- 100% of the Parts are Tested for ILM (Note 2)
- Smooth and Optimized Switching
- Low Saturation Voltage: V_{CE(Sat)} = 1.45 V (Typ.) @ I_C = 75 A
- No Reverse Recovery / No Forward Recovery
- Tight Parameter Distribution
- RoHS Compliant

Applications

- Charging Station (EVSE)
- UPS, ESS
- Solar Inverter
- PFC, Converters

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise noted)

Parame	Symbol	Value	Unit			
Collector-to-Emitter Voltage		V _{CES}	650	V		
Gate-to-Emitter Voltage		V_{GES}	±20			
Transient Gate-to-Emitter $(t_p < 0.5 \ \mu s, D < 0.001)$	Voltage		±30			
Collector Current	T _C = 25°C (Note 1)	Ι _C	110	А		
	$T_C = 100^{\circ}C$		75			
Power Dissipation	T _C = 25°C	PD	385	W		
	$T_{\rm C} = 100^{\circ}{\rm C}$]	192			
Pulsed Collector Current	T _C = 25°C (Note 2)	I _{LM}	300	А		
	T _C = 25°C (Note 3)	I _{CM}	300			
Diode Forward Current	$T_{C} = 25^{\circ}C$ (Note 1)	١ _F	60	А		
	$T_{C} = 100^{\circ}C$		50			
Pulsed Diode Maximum Forward Current	$T_{C} = 25^{\circ}C$	I _{FM}	200	A		
Operating Junction and Storage Temperature Range		T _J , T _{STG}	–55 to +175	°C		
Maximum Lead Temperature for Soldering Purposes		ΤL	260	°C		
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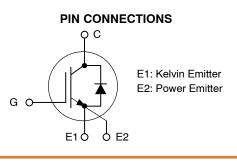
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Value limit by bond wire

2. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, Inductive Load, 100% tested

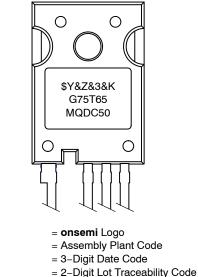
3. Repetitive rating: pulse width limited by max. junction temperature

BV _{CES}	V _{CE(sat)}	Ι _C
650 V	1.45 V	75 A





MARKING DIAGRAM



&K G75T65MQDC50 = Specific Device Code

\$Y

&Z

&З

ORDERING INFORMATION

Device	Package	Shipping
FGH4L75T65MQDC50	TO-247	30 Units / Tube
	–4LD	

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance Junction-to-Case, for IGBT	$R_{\theta JC}$	0.39	°C/W
Thermal Resistance Junction-to-Case, for Diode	$R_{ extsf{ heta}JCD}$	0.74	
Thermal Resistance Junction-to-Ambient	R_{\thetaJA}	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

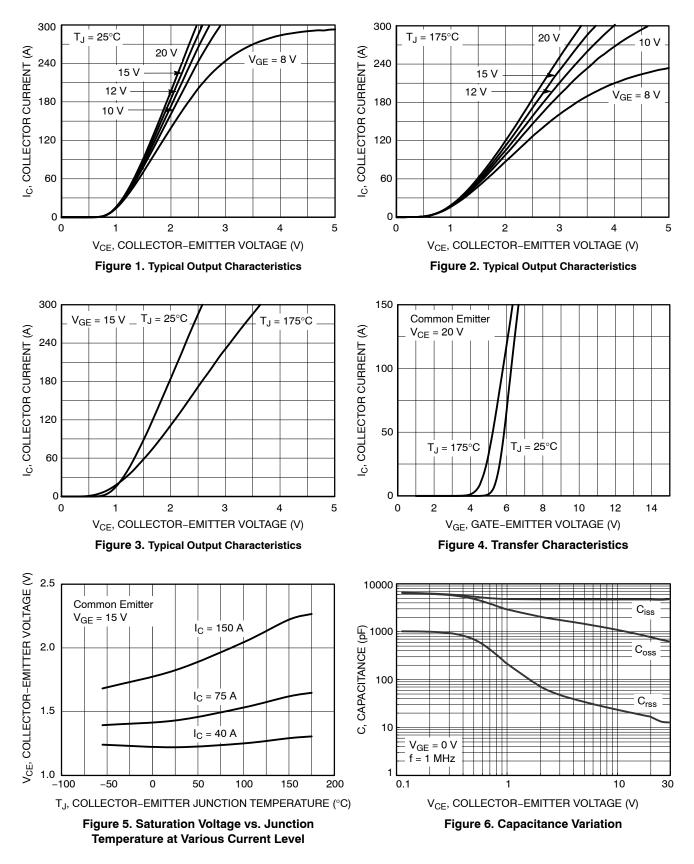
Parameter	Test Conditions	Symbol	Min	Тур	Мах	Unit
OFF CHARACTERISTICS						
Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	V_{GE} = 0 V, I _C = 1 mA	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I _C = 1 mA	$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	_	0.5	-	V/°C
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	V_{GE} = 0 V, V_{CE} = 650 V	I _{CES}	-	-	250	μΑ
Gate Leakage Current, Collector-emitter Short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	-	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 75 \text{ mA}$	V _{GE(th)}	3.0	4.5	6.0	V
Collector-emitter Saturation Voltage	V_{GE} = 15 V, I _C = 75 A, T _J = 25°C	V _{CE(sat)}	-	1.45	1.8	V
	V_{GE} = 15 V, I _C = 75 A, T _J = 175°C		_	1.65	-	
DYNAMIC CHARACTERISTICS		•				
Input Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	Cies	-	4770	-	pF
Output Capacitance		C _{oes}	-	619	-	-
Reverse Transfer Capacitance		C _{res}	-	13	-	
Gate Charge Total	V_{CC} = 400 V, I_{C} = 75 A, V_{GE} = 15 V	Qg	-	146	-	nC
Gate-to-emitter Charge		Q _{ge}	-	26	-	
Gate-to-collector Charge		Q _{gc}	-	34	-	
SWITCHING CHARACTERISTICS, INDUC	TIVE LOAD					
Turn-on Delay Time	$T_{J} = 25^{\circ}C, V_{CC} = 400 V,$	t _{d(on)}	-	24	-	ns
Rise Time	I_{C} = 37.5 A, R_{G} = 10 Ω , V _{GE} = 15 V, Inductive Load	t _r	-	16	-	
Turn-off Delay Time		t _{d(off)}	-	192	-	
Fall Time		t _f	-	16	-	
Turn-on Switching Loss		Eon	-	0.31	-	mJ
Turn-off Switching Loss		E _{off}	-	0.49	-	
Total Switching Loss		E _{ts}	-	0.81	-	
Turn-on Delay Time	$T_{J} = 25^{\circ}C, V_{CC} = 400 V,$	t _{d(on)}	-	29	-	ns
Rise Time	I_{C} = 75 A, R_{G} = 10 Ω , V _{GE} = 15 V, Inductive Load	t _r	-	27	-	
Turn-off Delay Time		t _{d(off)}	-	187	-	
Fall Time		t _f	-	18	-	
Turn-on Switching Loss		E _{on}	-	0.72	-	mJ
Turn-off Switching Loss		E _{off}	_	0.96	-	
Total Switching Loss		E _{ts}	_	1.68	-	

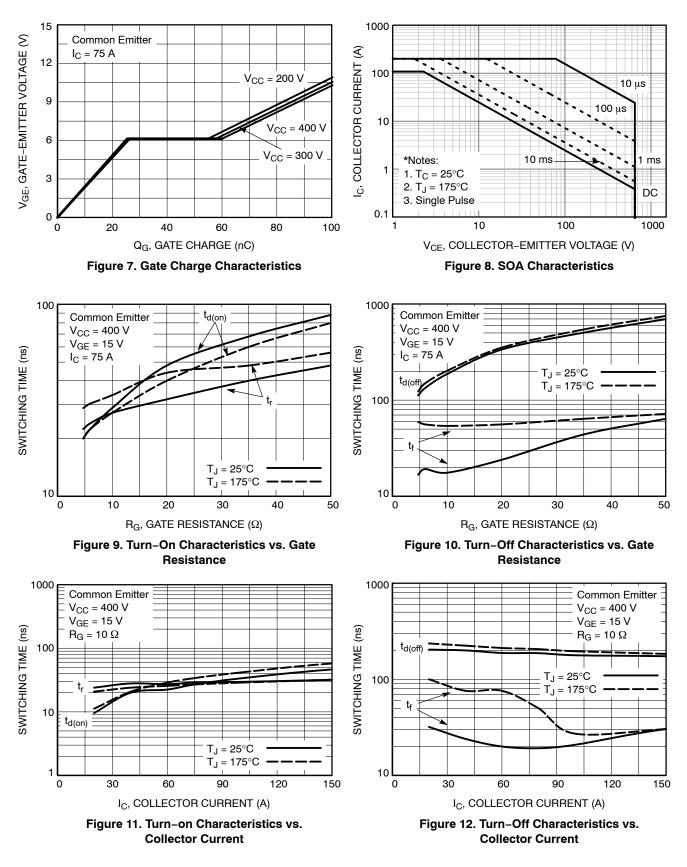
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

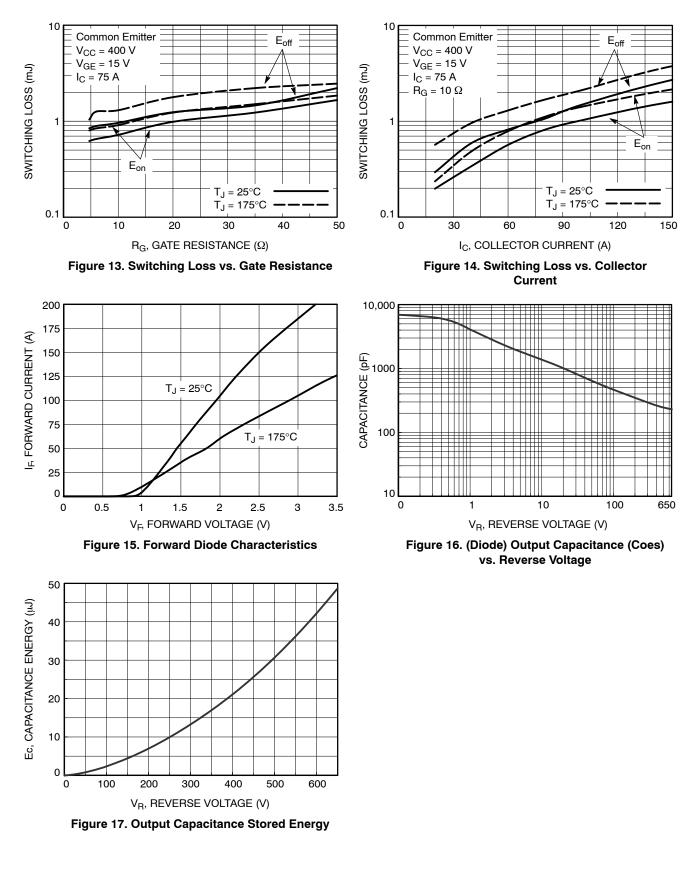
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS, IN	IDUCTIVE LOAD	•				
Turn-on Delay Time	$T_{J} = 175^{\circ}C, V_{CC} = 400 V,$	t _{d(on)}	-	24	-	ns
Rise Time	I _C = 37.5 A, R _G = 15 Ω, V _{GE} = 10 V, Inductive Load	tr	-	20	-	1
Turn-off Delay Time		t _{d(off)}	-	220	-	1
Fall Time		t _f	-	72	-	1
Turn-on Switching Loss		Eon	-	0.41	-	mJ
Turn-off Switching Loss		E _{off}	-	0.82	-	1
Total Switching Loss		E _{ts}	-	1.23	-	1
Turn-on Delay Time	$T_{J} = 175^{\circ}C, V_{CC} = 400 V,$	t _{d(on)}	-	27	-	ns
Rise Time	I_{C} = 75 A, R_{G} = 15 Ω , V _{GE} = 10 V, Inductive Load	tr	-	34	-	1
Turn-off Delay Time		t _{d(off)}	-	202	-	1
Fall Time		t _f	-	54	-	1
Turn-on Switching Loss		Eon	-	0.91	-	mJ
Turn-off Switching Loss		E _{off}	-	1.30	-	1
Total Switching Loss		E _{ts}	-	2.20	-	1

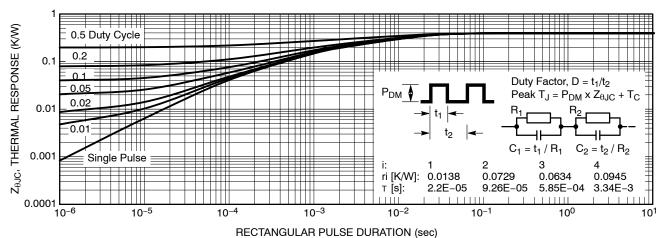
Diode Forward Voltage	I _F = 50 A, T _J = 25°C	V _F	-	1.46	1.7	V
	I _F = 50 A, T _J = 175°C		-	1.83	-	
Total Capacitance	V_R = 400 V, f = 1 MHz, T _J = 25°C	С	-	210	-	pF
	V_R = 600 V, f = 1 MHz, T _J = 25°C		-	202	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.











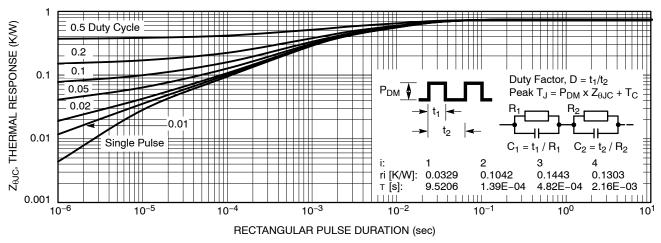
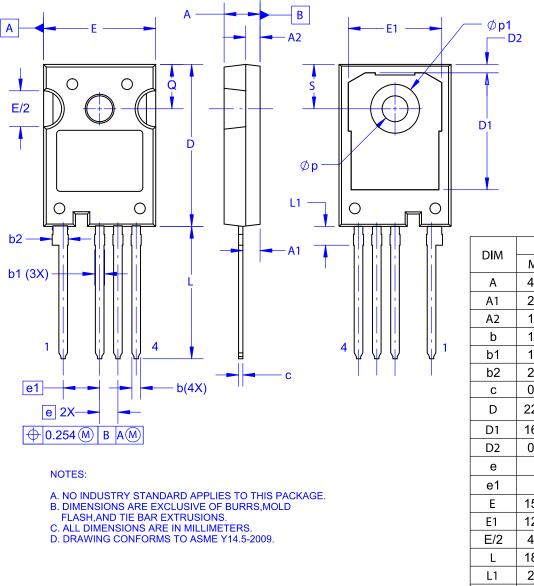


Figure 19. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MILLIMETERS					
DIM	MIN	MIN NOM MA				
А	4.80	5.00	5.20			
A1	2.10	2.40	2.70			
A2	1.80	2.00	2.20			
b	1.07	1.20	1.33			
b1	1.20	1.40	1.60			
b2	2.02	2.22	2.42			
С	0.50	0.60	0.70			
D	22.34	22.54	22.74			
D1	16.00	16.25	16.50			
D2	0.97	1.17	1.37			
е	2	2.54 BSC				
e1	Ę	5.08 BSC	2			
Е	15.40	15.60	15.80			
E1	12.80	13.00	13.20			
E/2	4.80	5.00	5.20			
L	18.22	18.42	18.62			
L1	2.42	2.62	2.82			
р	3.40	3.60	3.80			
p1	6.60	6.80	7.00			
Q	5.97	6.17	6.37			
S	5.97	6.17	6.37			

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